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CLAIMS

- 1. A biaxially oriented polyester film for use in a capacitor having high heat resistance, comprising a polyester (A) as a main component and a polyimide (B), and having a glass transition temperature in the range of 105°C to 145°C and an elongation at break in a machine direction of 70% to 150%.
- 2. A polyester film for use in a capacitor having high heat resistance, according to claim 1, which has a surface roughness (Ra) in the range of 10 nm to 140 nm.
- 3. A polyester film for use in a capacitor having high heat resistance, according to claim 1, wherein the polyester (A) is a polyester composed mainly of ethylene terephthalate.
- 4. A polyester film for use in a capacitor having high heat resistance, according to claim 1, wherein the polyimide(B) is a polyimide composed of polyether imide.
- 5. A polyester film for use in a capacitor having high heat resistance, according to claim 1, which has an onset temperature of dielectric loss (tan δ) in the range of 85°C to 120°C.

- 6. A polyester film for use in a capacitor having high heat resistance, according to claim 1, which has an insulation volume resistance (IR) in the range of 1.0 \times 10¹⁴ Ω ·cm to 5.0 \times 10¹⁶ Ω ·cm at 125°C.
- 7. A polyester film for use in a capacitor having high heat resistance, according to claim 1, which has the polyimide (B) in a content in the range of 5 to 30% by weight based on the total weight of said film.
- 8. A polyester film for use in a capacitor having high heat resistance, according to claim 1, which has a thermal shrinkage of not more than 2.5% after a lapse of 30 minutes at 150°C.
- 9. A metallized film for use in a capacitor having high heat resistance, comprising one polyester film for use in a capacitor according to any one of claims 1 to 8, and having a metallized layer disposed on at least one surface of said film.
- 10. A capacitor having high heat resistance, comprising the metallized film for use in a capacitor according to claim 9.